

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
Teng-Wang HUANG		10/04/2004
RECEIVING PARTY DATA		
Name:	Nanya Technology Corporation	
Street Address:	Hwa-Ya Technology Park 669	
Internal Address:	Fuhsing 3 Rd.	
City:	Kueishan Taoyuan	
State/Country:	TAIWAN	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	10943017	
CORRESPONDENCE DATA		
Fax Number:	(301)762-4056	
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
Phone:	301/424-3640	
Email:	jkw@usiplaw.com	
Correspondent Name:	Edell, Shapiro & Finnan	
Address Line 1:	1901 Research Blvd.	
Address Line 2:	Suite 400	
Address Line 4:	Rockville, MARYLAND 20850	
NAME OF SUBMITTER:	Patrick J. Finnan	
Total Attachments: 1 source=Executed Assignment HUANG#page1.tif		

OP \$40.00 10943017

ASSIGNMENT

For good and valuable consideration, I, Teng-Wang Huang, a citizen of Taiwan, residing at Am Brauhaus 10, 01099 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Nanya Technology Corporation**, a corporation organized and existing under the laws of Taiwan, having its principal place of business at Hwa-Ya Technology Park 669, Fuhsing 3 Rd., Kueishan Taoyuan, Taiwan, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on 09/17/2004 US. Serial No. _____,

entitled: **A Method of Etching Silicon Anisotropically**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: Teng-Wang Huang DATE: 04.20.04
Teng-Wang Huang